LC25W*A / 2.5 Gb/s Buried Het Laser 175 km Reach LC25EW*A With Optional Etalon Stabilization

Features

2.5 Gb/s operation

+/- 100 pm wavelength stability over life

Optional etalon wavelength stabilization to within +/- 32 pm

Narrow spectral line-width

Internal TEC with precision NTC thermistor for temperature control

Entire C & L-band ITU wavelengths available (1527 nm to 1605 nm)

Code reduction with single product for reaches up to 175 km

GalnAsP SLMQW DFB single frequency laser chip

InGaAs monitor photo-diode

Hermetically sealed 14-pin butterfly package with optical isolator

Applications

WDM

On-off ramps

Long-Haul

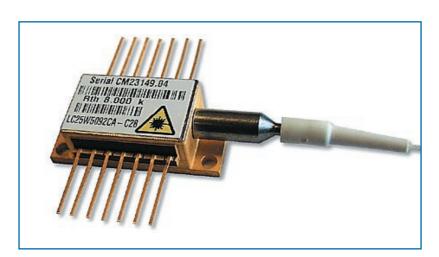
DWDM on ITU Grid

Description

This laser module employs the Nortel Networks strained layer MQW Buried Heterostructure DFB laser chip, and has been designed specifically for use in Wavelength Division Multiplexed (WDM) 2.5 Gb/s long distance optical fiber trunk systems. The device is packaged in a hermetically sealed 14-pin butterfly package incorporating an isolator and monitor photodiode for control of the power of the laser over life and all operating conditions.

The device is available with a number of power options depending on application and link span requirements.

An optional internal etalon is available for wavelength stabilization for DWDM applications.





Parameters

Parameter	Conditions	Min	Тур	Max	Unit
Threshold current (Ith)			10	22	mA
Slope efficiency by product	2 mW 3 mW 4 mW 10 mW	0.04 0.06 0.08 0.143		0.09 0.13 0.17 0.43	mW/mA
RF input reflection coef (S11)	(1)			-10	dB
Forward voltage			1.3	1.8	V
Peak wavelength (λp)	(2)	1527		1605	nm
Dispersion penalty at 175 km	(3)			2	dB
Time averaged spectral linewidth	-20 dB		0.1	0.6	nm
Side-mode suppression		32	40		dB
Optical rise/fall time	(4)			125	ps
Monitor photo current	Unlocked Etalon locked	50 40	250 250	1200 360	μΑ
Monitor dark current				100	nA
Thermistor resistance			10		kΩ
Heatpump current	70°C case temperature	250	600	900	mA
Heatpump voltage	70°C case temperature		1.0	2.4	V
Change of λp with temp.	20 to 35		0.09		nm/°C
Change in λ over life and operating conditions	Unlocked (5) Etalon locked	-100 -32		100 32	pm

(1) 50 Ω measurement system, f = dc - 3 GHz

 (2) Submount temperature between 20°C & 35°C start of life to achieve required λ p
 (3) Standard product dispersion penalty will be compliant to the specified link length of 175 km using an extinction ratio of 10 dB. Fiber dispersion characteristics are derived from the following equation

$$D(\lambda) = \frac{So}{4} (\lambda - \frac{\lambda_0^4}{\lambda^3}) ps / (nm.km)$$

Where So = 0.092 ps/(nm².km) and λ = 1302 nm

(4) Measurements determined from 20 - 80% pk - pk

(5) For more information on wavelength control and drift over life refer to applications note DR1670

Absolute Maximum Ratings

Parameter	Min	Max	Unit
Case operating temperature	0	70	°C
Laser submount operating temperature (1)	20	35	°C
Storage temperature	-40	85	°C
Laser current above Ith		100	mA
Laser reverse voltage		1.0	٧
Laser reverse current		10	μΑ
Monitor diode bias		-10	V
Heatpump voltage		2.4	V
Fiber bend radius	30		mm

(1) Product without locker can be tuned onto the next 100 GHz ITU channel in the red shift direction (2x100 GHz tunability) by increasing the submount temperature to a maximum of 43°C

Reliability/Quality

Meets Qualification requirements of Telcordia / Bellcore GR468-Core for central office environment.

Operating reliability <500 FITs1 in 15 years.

1- Assumes laser die submount held at <35°C by internal thermoelectric cooler, mean forward current of 35 mA, and end of life limits based on 10 mA increase in Ith and 25% change in laser efficiency.

Outline Drawing

Dimensions in mm

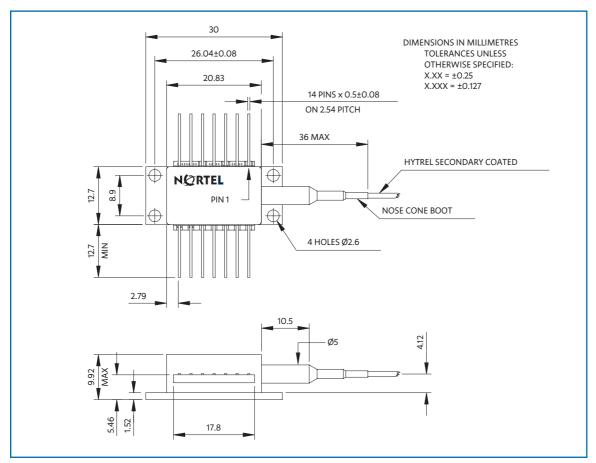


Figure 1: Outline Drawing

Instructions for Use - LC25W*A and LC25EW*A

Pin 1 and Pin 2 Thermistor

The thermistor is used in a control loop in conjunction with the thermo-electric cooler to maintain the laser submount temperature at the required value for wavelength. Operating current should be less than 100 μA to prevent self-heating errors.

For etalon stabilised devices the thermistor is used for the initial set up of the submount temperature at the required wavelength value. Operating current should be less than 100 μA to prevent self-heating errors. Once the initial submount temperature has been achieved control of the TEC current is handed over to the etalon locking circuit to achieve fine tuning.

Pin 3 Laser DC bias (-)

Laser bias current (negative with respect to package ground) is applied via this pin which forms one side of the bias-T connection to the laser cathode.

Pin 4 Monitor anodes, Pin 5 Common Monitor cathode

The back facet monitor provides a mean power reference for the laser and is normally operated with a 5 V reverse bias.

For etalon stabilized devices the monitor diodes are arranged in the package such that they give an equal monitor current when the laser wavelength is matched to the ITU grid. A reverse bias must be applied equally across each of the monitors, this is commonly achieved by applying 5 V to Pin 5.

Pin 6 TEC (+), Pin 7 TEC (-)

Applying a positive voltage on pin 6 with respect to pin 7 will cause the internal submount to be cooled relative to the case temperature. Reversing the polarity will raise the submount temperature relative to the case. The TEC supply should be capable of delivering up to $0.9~\mathrm{A}$ at $2.4~\mathrm{V}$.

Pin 8, 9, 11, 13 Case ground

These pins must be grounded in all applications

Pin 10

This pin is not connected for the LC25W product and it should be grounded if possible. For the Etalon locked product this pin is used for the monitor long anode. The monitor diodes are arranged such that they give an equal monitor current when the laser wavelength is matched to the ITU grid. A reverse bias must be applied equally across each of the monitors, this is commonly achieved by applying 5 V to pin 5.

Pin 12 Laser modulation (-)

The data input (modulation current) is applied via this pin which is a nominal 25 Ohm impedance coplanar line.

Pin 14 N/C

This pin is not connected. It should be grounded if possible.

Connections

	Without Etalon		With Etalon	
Pin	Function	Pin	Function	
1	Thermistor	1	Thermistor	
2	Thermistor	2	Thermistor	
3	Laser DC bias (-)	3	Laser DC bias (-)	
4	Monitor Anode (-)	4	Monitor Short Anode (-)	
5	Monitor Cathode (+)	5	Monitor Cathode (+)	
6	TEC (+)	6	TEC (+)	
7	TEC (-)	7	TEC (-)	
8	Case Ground	8	Case Ground	
9	Case Ground	9	Case Ground	
10	Not Connected	10	Monitor Long Anode (-)	
11	Case Ground	11	Case Ground	
12	Laser Modulation (-)	12	Laser Modulation (-)	
13	Case Ground	13	Case Ground	
14	Not Connected	14	Not Connected	

Preliminary Datasheet

Safety Information

Laser safety classifications: IEC 60825-1:1993 +A1:1997 Class 3A IEC 60825-1:1993 +A1:1997 +A2:2000 Class 1M 21 CFR Ch.1 (4-1-97 Edition) Class IIIb

Electrostatic discharge: ESD threshold >500 V TA-TSY-000870 class 3.

Ordering Information

LC25	[Etalon Option]	[Wavelength]	[Power Option]	[Reach]	[Connector]
	$\mathbf{W} = \text{none}$	***	$\mathbf{E} = 2 \text{ mWpk}$	A = 175 km	C28 = SC/PC
	EW = Etalon		C = 3 mWpk		C34 = FC/PC
			A = 4 mWpk		C57 = LC
			$\mathbf{B} = 10 \text{ mWpk}$		C59 = MU

**** = Last four digits of wavelength value E.g. for $\lambda p = 1545.32$ nm **** = 4532

Product without locker can be tuned onto the next 100 GHz ITU channel in the red shift direction (2x100 GHz tunability) i.e. an LC25W4135CA-C28 can be tuned to service the 1542.14 nm ITU channel.

Fiber length 1130 to 1190 mm

Other connector types are available on request.

E.g. LC25W4532BA-C28 is a 10 mW 1545.32 nm device with an SC connector for use in a 175 km application.

E.g. **LC25EW4532EA-C28** is a 2 mW 1545.32 nm device with an SC connector for use in a 175 km application with optional etalon stabilization.



REFERENCE IEC 60825-1: Edition 1.2



THIS PRODUCT COMPLIES WITH 21 CFR 1040.10









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